# 2.5V Drive Pch+SBD MOS FET **US5U29**

# ●Structure

Silicon P-channel MOS FET Schottky Barrier DIODE

### ● Features

- 1) The US5U29 combines Pch MOS FET with a Schottky barrier diode in a TUMT5 package.
- 2) Low on-resistance with fast switching.
- 3) Low voltage drive (2.5V).
- 4) Built-in schottky barrier diode has low forward voltage.

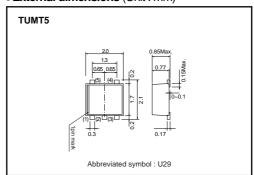
# Applications

Load switch, DC/DC conversion

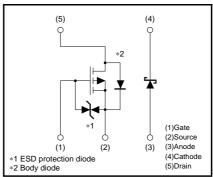
## Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
US5U29		0

## ●External dimensions (Unit:mm)



## ●Equivalent circuit



Rev.C

# ● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter	Symbol	Limits	Unit				
Drain-source voltage	V <sub>DSS</sub>	-20	V				
Gate-source voltage	V <sub>GSS</sub>	±12	V				
Duning and and	Continuous	I <sub>D</sub>	±1	A			
Drain current	Pulsed	IDP *1	±4	Α			
Source current	Continuous	Is	-0.4	Α			
(Body diode)	Pulsed	Isp *1	-4	Α			
Channel temperature	Tch	150	°C				
Power dissipation	P <sub>D</sub> *3	0.7	W / ELEMENT				
<di></di>							
Repetitive peak reverse volt	$V_{RM}$	25	V				
Reverse voltage	VR	20	V				
Forward current	lF	0.7	Α				
Forward current surge peak	I <sub>FSM</sub> *2	3.0	Α				
Junction temperature	Tj	150	°C				
Power dissipation	P <sub>D</sub> *3	0.5	W / ELEMENT				
<mosfet and="" di=""></mosfet>							
Total power dissipation	P <sub>D</sub> *3	1.0	W / TOTAL				
Range of Storage temperatu	Tstg	-55 to +150	°C				

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 60Hz•1cyc. \*3 Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

# <MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μΑ	Vgs=±12V, Vps=0V
Drain-source breakdown voltage	V(BR) DSS	-20	-	-	٧	In=-1mA, Vgs=0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	Vps=-20V, Vgs=0V
Gate threshold voltage	VGS (th)	-0.7	-	-2.0	٧	VDS=-10V, ID=-1mA
	*	-	280	390	mΩ	ID=-1A, VGS=-4.5V
Static drain-source on-starte resistance	RDS (on)	-	310	430	mΩ	ID=-1A, VGS=-4V
resistance		-	570	800	mΩ	ID=-0.5A, VGS=-2.5V
Forward transfer admittance	Y <sub>fs</sub> *	0.7	_	_	S	VDS=-10V, ID=-0.5A
Input capacitance	Ciss	-	150	_	рF	V <sub>DS</sub> =-10V
Output capacitance	Coss	-	20	-	рF	Vgs=0V
Reverse transfer capacitance	Crss	-	20	_	рF	f=1MHz
Turn-on delay time	td (on) *	-	9	_	ns	ID=-0.5A
Rise time	tr *	-	8	_	ns	V <sub>DD</sub> ≒-15V V <sub>GS</sub> =-4.5V
Turn-off delay time	td (off) *	-	25	-	ns	VGS=-4.5 V   RL=30Ω
Fall time	t <sub>f</sub> *	-	10	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	-	2.1	-	nC	V <sub>DD</sub> ≒-15V V <sub>GS</sub> =-4.5V
Gate-source charge	Qgs *	-	0.5	-	nC	ID=-1A
Gate-drain charge	Qgd *	-	0.5	_	nC	RL=15Ω R <sub>G</sub> =10Ω

<sup>\*</sup> Pulsed

<Body diode (source-drain)>

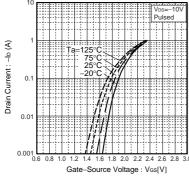
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	_	_	-1.2	V	Is=-0.4A, Vgs=0V

### <Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage drop	VF	-	-	0.49	V	I==0.7A
Reverse current	lr	_	-	200	μΑ	V <sub>R</sub> =20V



#### •Electrical characteristic curves



Source Strain Control Control

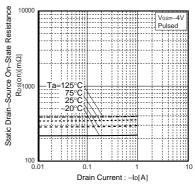
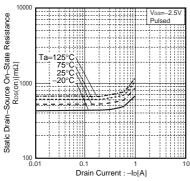


Fig.1 Typical Transfer Characteristics

Fig.2 Static Drain-Source On-State Resistance vs.Drain Current ( I )

Fig.3 Static Drain–Source On–State Resistance vs.Drain Current ( II )



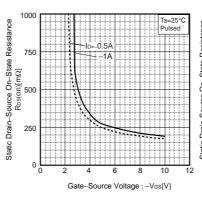


Fig.5 Static Drain–Source On–State Resistance vs.Gate–Source Voltage

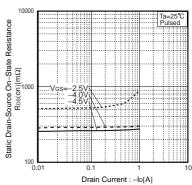
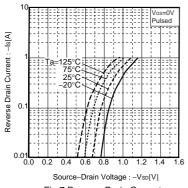


Fig.6 Static Drain–Source On–State Resistance vs.Drain Current



Source–Drain Voltage : –Vsb[V]
Fig.7 Reverse Drain Current
vs. Source-Drain Current

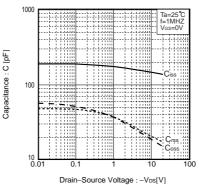


Fig.8 Typical Capactitance vs.Drain-Source Voltage

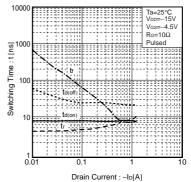


Fig.9 Switching Characteristics

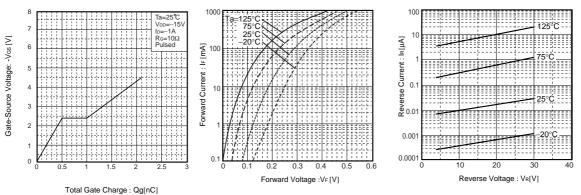


Fig.10 Dynamic Input Characteristics

Fig.11 Forward Temperature Characteristics

Fig.12 Reverse Temperature Characteristics

### Measurement circuits

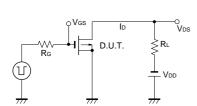


Fig.13 Switching Time Measurement Circuit

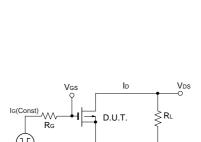


Fig.15 Gate Charge Measurement Circuit

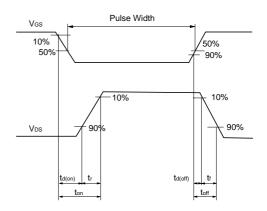


Fig.14 Switching Waveforms

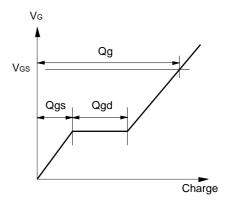


Fig.16 Gate Charge Waveforms

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